

Description

Silicon Controlled Rectifiers (SCR) are reverse blocking triode thyristor semiconductor devices designed for power switching and phase control applications. They are all-diffused devices backed by years of design and field experience.

Features

- Low Gate Current
- Low On-State Voltage
- Hermetic Packaging
- Long Creepage Path
- Thermal Fatigue Resistant
- Excellent Surge Rating
- Available JAN/JANTX
- Slash Sheet MIL-PRF-19500/108

Applications

- Phase Control
- Power Supplies
- Static Switch
- Battery Chargers
- Motor Control

Ordering Information

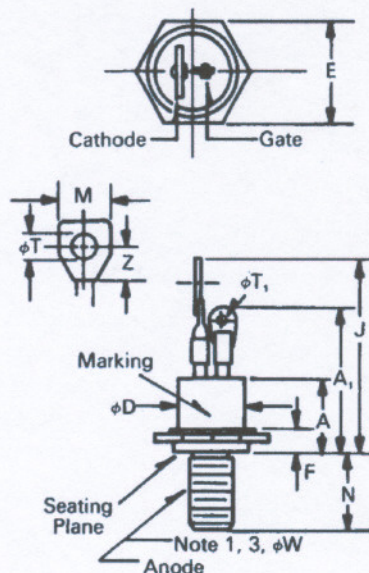
Type	Voltage V_{DRM}/V_{RRM} @ $I_{T(AV)} = 16$ Amps	Available JAN/JAN TX
2N681	25	
2N682	50	✓
2N683	100	✓
2N684	150	
2N685	200	✓
2N686	250	✓
2N687	300	✓
2N688	400	✓
2N689	500	✓
2N690	600	✓
2N691	700	
2N692	800	

Phase Control SCR 16 Amperes / 25-800 Volts



Outline Drawing

Complies with TO-48



Dim.	Inches		Metric(mm)	
	Min	Max	Min	Max
A	.330	.505	8.38	12.83
A ₁		.880		22.35
ØD		.544		13.82
E	.544	.562	13.82	14.27
F	.113	.152	2.87	3.86
J		1.193		30.30
M	.210	.300	5.33	7.62
N	.422	.453	10.72	11.51
ØT	.125	.165	3.18	4.19
ØT ₁	.060	.075	1.52	1.91
Z	.120		3.05	
ØW	¼-28 UNF-2A			

Absolute Maximum Ratings, (Tj = +125°C unless otherwise specified)

	Symbol	2N681	2N682	2N683	2N684	2N685	2N686	Units
Repetitive peak off-state voltage	V _{DRM}	25	50	100	150	200	250	Volts
Non-repetitive peak off-state voltage	V _{DSM}	35	75	150	225	300	350	Volts
Repetitive peak reverse voltage	V _{RRM}	25	50	100	150	200	250	Volts
Non-repetitive peak reverse voltage	V _{RSM}	35	75	150	225	300	350	Volts
		2N687	2N688	2N689	2N690	2N691	2N692	
Repetitive peak off-state voltage	V _{DRM}	300	400	500	600	700	800	Volts
Non-repetitive peak off-state voltage	V _{DSM}	400	500	600	720	840	960	Volts
Repetitive peak reverse voltage	V _{RRM}	300	400	500	600	700	800	Volts
Non-repetitive peak reverse voltage	V _{RSM}	400	500	600	720	840	960	Volts
ALL DEVICE TYPES 2N681 through 2N692								
RMS On-State Current	I _{T(RMS)}	25						Amps
Average On-state Current, Tc = 67°C	I _{T(AV)}	16						Amps
Peak One-Cycle Surge (Non-Repetitive) On-State Current (60 Hz)	I _{TSM}	150						Amps
Peak One-Cycle Surge (Non-Repetitive) On-State Current (50 Hz)	I _{TSM}	136						Amps
I ² t (for Fusing), 8.3 ms	I ² t	93.4						A ² sec
Critical Rate-of-Rise of On-State Current (Repetitive)	di/dt	10						A/μs
Peak Gate Power Dissipation	P _{GM}	5						Watts
Average Gate Power Dissipation	P _{G(AV)}	0.5						Watts
Peak Forward Gate Voltage	V _{FGM}	10						Volts
Peak Forward Gate Current	I _{FGM}	2						Amps
Peak Reverse Gate Voltage	V _{RGM}	5						Volts
Storage Temperature	T _{STORAGE}	-65 to +150						°C
Operating Temperature	T _J	-65 to +125						°C
Mounting Torque	-	30						in-lb
Mounting Torque (metric)	-	35						kg-cm

Electrical Characteristics

Parameter	Conditions	Symbol	Device Types						Units
Voltage, Blocking State Maximums			2N681	2N682	2N683	2N684	2N685	2N686	
Forward Leakage, Peak	T _J = 125°C, V _D = V _{DRM}	I _{DRM}	13.0	13.0	13.0	13.0	12.0	11.0	mA
Reverse Leakage, Peak	T = 125°C, V _R = V _{RRM}	I _{RRM}	13.0	13.0	13.0	13.0	12.0	11.0	mA
			2N687	2N688	2N689	2N690	2N691	2N692	
Forward Leakage, Peak	T _J = 125°C, V _D = V _{DRM}	I _{DRM}	10.0	8.0	6.0	5.0	4.5	4.0	mA
Reverse Leakage, Peak	T = 125°C, V _R = V _{RRM}	I _{RRM}	10.0	8.0	6.0	5.0	4.5	4.0	mA
ALL DEVICE TYPES 2N681 through 2N692									
Current, Conducting State Maximums		Test Conditions	Symbol						Units
Peak On-State Voltage		T _C = 25°C, I _{FM} = 50 A	V _{TM}	2					Volts
Switching									
Typical Critical dv/dt exponential to V _{DRM}		T _J = 125°C, Gate Open	dv/dt	50					V/μs
Gate Parameters									
Gate Current to Trigger		T _J = 25°C, V _D = 12V, R _L = 50Ω	I _{GT}	40					mA
Gate Voltage to Trigger		T _J = 125°C, V _D = 12V, R _L = 50Ω	V _{GT}	3					Volts
Minimum Non-Triggering Gate Voltage		T _J = 125°C, V _D = ½V _{DRM}	V _{GD}	0.30					Volts

